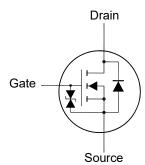
# MMBT7002BK

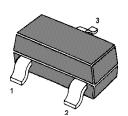
## N-Channel Enhancement Mode MOSFET

#### Features

- Very fast switching
- Built-in G-S Protection Diode
- Typical ESD Protection HBM Class 2

Classification	Voltage Range(V)
0A	< 125
0B	125 to < 250
1A	250 to < 500
1B	500 to < 1000
1C	1000 to < 2000
2	2000 to < 4000
3A	4000 to < 8000
3B	≥ 8000





1. Gate 2. Source 3. Drain SOT-23 Plastic Package

### Application

- Portable appliances
- Battery management

#### Absolute Maximum Ratings (at T<sub>a</sub> = 25°C unless otherwise specified)

Parameter	Symbol	Value	Unit	
Drain-Source Voltage	VDS	60	V	
Gate-Source Voltage	Vgs	± 20	V	
Continuous Drain Current	lo	ID 350		
Pulsed Drain Current <sup>1)</sup>	IDM	2	А	
Total Power Dissipation <sup>2)</sup>	Ptot	370	mW	
Operating Junction Temperature	Tj	150	°C	
Storage Temperature Range	T <sub>stg</sub>	- 65 to + 150	°C	

#### **Thermal Resistance Ratings**

Parameter	Symbol	Max.	Unit
Thermal Resistance from Junction to Ambient <sup>2)</sup>	R <sub>θJA</sub>	340	°C/W

<sup>1)</sup> Pulse Test: Pulse Width  $\leq$  100 µs, Duty Cycle  $\leq$  2%, Repetitive rating, pulse width limited by junction temperature T<sub>J(MAX)</sub> = 150°C.

<sup>2)</sup> Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

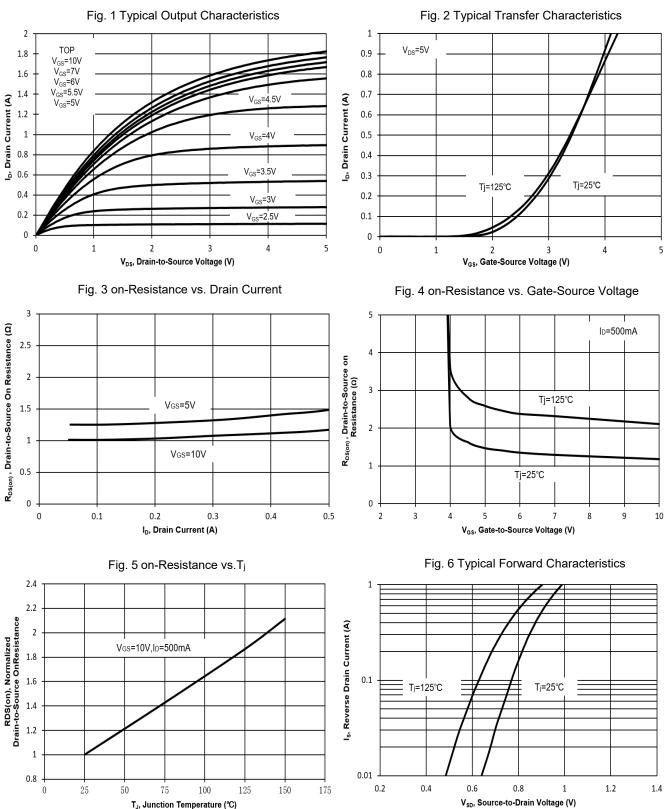


## Characteristics at Ta = 25°C unless otherwise specified

Parameter	Symbol	Min.	Тур.	Max.	Unit
STATIC PARAMETERS					
Drain-Source Breakdown Voltage at I <sub>D</sub> = 10 μA	V <sub>(BR)DSS</sub>	60	-	-	V
Zero Gate Voltage Drain Current at V <sub>DS</sub> = 60 V	I <sub>DSS</sub>	-	-	1	μA
Gate-Source Leakage at V <sub>GS</sub> = ± 20 V	lgss	-	-	± 10	μA
Gate-Source Threshold Voltage at $V_{DS}$ = $V_{GS}$ , $I_D$ = 250 $\mu$ A	$V_{GS(th)}$	1.1	-	2.1	V
Drain-Source On-State Resistance at $V_{GS}$ = 10 V, $I_D$ =500 mA at $V_{GS}$ = 5 V, $I_D$ = 50 mA	R <sub>DS(on)</sub>	RDS(on)			Ω
DYNAMIC PARAMETERS					
Gate resistance at V <sub>DS</sub> = 0 V, f = 1 MHz	Rg	-	37	-	Ω
Forward Transconductance at V <sub>DS</sub> = 10 V, I <sub>D</sub> =200 mA	<b>g</b> fs	-	307	-	mS
Input Capacitance at $V_{DS}$ = 10 V, $V_{GS}$ = 0 V, f = 1 MHz	Ciss	-	31	-	pF
Output Capacitance at $V_{DS}$ =10 V, $V_{GS}$ = 0 V, f = 1 MHz	Coss	-	11	-	pF
Reverse Transfer Capacitance at V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz	Crss	-	8	-	pF
Total Gate Charge at $V_{DS}$ = 30 V, $I_D$ = 1 A, $V_{GS}$ = 10 V at $V_{DS}$ = 30 V, $I_D$ = 1 A, $V_{GS}$ = 4.5 V	Qg	-	1.1 0.4	-	nC
Gate to Source Charge at $V_{DS}$ = 30 V, $I_D$ = 1 A, $V_{GS}$ = 10 V	$Q_{gs}$	-	0.5	-	nC
Gate to Drain Charge at $V_{DS}$ = 30 V, $I_D$ = 1 A, $V_{GS}$ = 10 V	$Q_{gd}$	-	0.2	-	nC
Turn-On Delay Time at V <sub>DD</sub> = 30 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 1 A, R <sub>g</sub> = 6.8 $\Omega$	t <sub>d(on)</sub>	-	4.8	-	ns
Turn-On Rise Time at V <sub>DD</sub> = 30 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 1 A, R <sub>g</sub> = 6.8 $\Omega$	tr	-	3	-	ns
Turn-Off Delay Time at V <sub>DD</sub> = 30 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 1 A, R <sub>g</sub> = 6.8 $\Omega$	$t_{d(off)}$	-	4.4	-	ns
Turn-Off Fall Time at V <sub>DD</sub> = 30 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 1 A, R <sub>g</sub> = 6.8 $\Omega$	t <sub>f</sub>	-	15	-	ns
Body-Diode PARAMETERS					
Drain-Source Diode Forward Voltage at Is = 115 mA	Vsd	-	-	1.1	V
Body-Diode Continuous Current	ls	-	-	350	mA
Body Diode Reverse Recovery Time at I <sub>s</sub> = 1 A, di/dt = 100 A / μs	t <sub>rr</sub>	-	8.4	-	ns
Body Diode Reverse Recovery Charge at Is = 1 A, di/dt = 100 A / μs	Qrr	-	3.6	-	nC

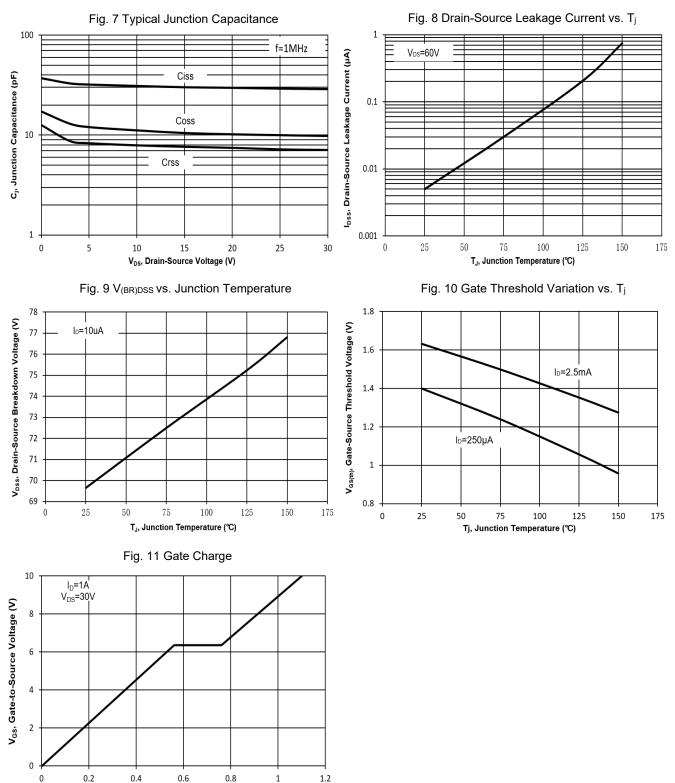


## **Electrical Characteristics Curves**





## **Electrical Characteristics Curves**

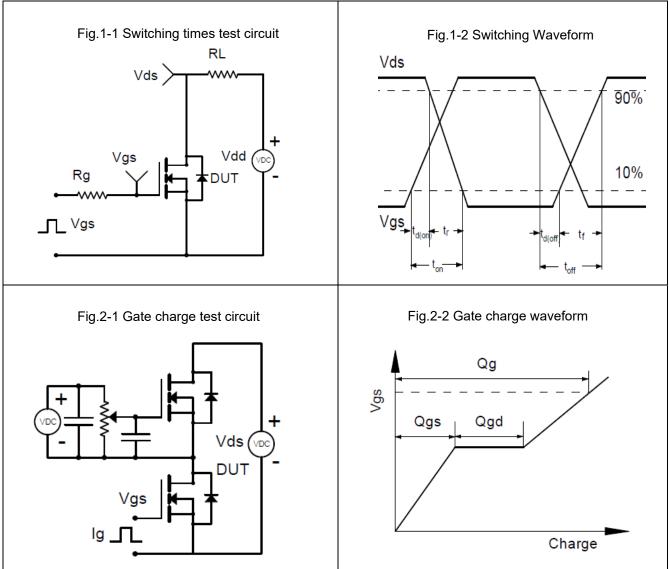




Q<sub>g</sub>, Total Gate Charge (nC)

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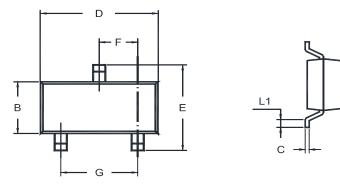
**Test Circuits** 

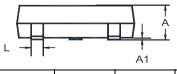




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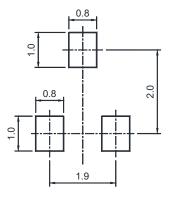
## Package Outline (Dimensions in mm)





Unit	А	A1	В	С	D	E	F	G	L	L1
mm	1.20	0.100	1.40	0.19	3.04	2.6	1.02	2.04	0.51	0.2
mm	0.89	0.013	1.20	0.08	2.80	2.2	0.89	1.78	0.37	MIN

### **Recommended Soldering Footprint**

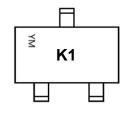


### Packing information

Package Tape Width (mm)		Pit	tch	Reel	Size	Per Reel Packing Quantity	
		mm	inch	mm	inch		
SOT-23	8	4 ± 0.1	0.157 ± 0.004	178	7	3,000	

### **Marking information**

- " K1 " = Part No.
- " YM " = Date Code Marking
- " Y " = Year
- " M " = Month
- Font type: Arial



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SOT-23